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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Not For New Designs
Core Processor	8051
Core Size	8-Bit
Speed	25MHz
Connectivity	EBI/EMI, SMBus (2-Wire/I²C), SPI, UART/USART, USB
Peripherals	Brown-out Detect/Reset, POR, PWM, Temp Sensor, WDT
Number of I/O	40
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2.25K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 20x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-TQFP
Supplier Device Package	48-TQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f345-gqr

2. Absolute Maximum Ratings

Table 2.1. Absolute Maximum Ratings*

Parameter	Conditions	Min	Typ	Max	Units
Ambient temperature under bias		–55		125	°C
Storage Temperature		–65		150	°C
Voltage on any Port I/O Pin or $\overline{\text{RST}}$ with respect to GND		–0.3		5.8	V
Voltage on V_{DD} with respect to GND		–0.3		4.2	V
Maximum Total current through V_{DD} and GND				500	mA
Maximum output current sunk by $\overline{\text{RST}}$ or any Port pin				100	mA

***Note:** Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the devices at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

SFR Definition 5.2. AMX0N: AMUX0 Negative Channel Select

R	R	R	R/W	R/W	R/W	R/W	R/W	Reset Value
-	-	-	AMX0N4	AMX0N3	AMX0N2	AMX0N1	AMX0N0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0xBA

Bits7–5: UNUSED. Read = 000b; Write = don't care.
Bits4–0: AMX0N4–0: AMUX0 Negative Input Selection.
Note that when GND is selected as the Negative Input, ADC0 operates in Single-ended mode. For all other Negative Input selections, ADC0 operates in Differential mode.

AMX0N4-0	ADC0 Negative Input (32-pin Package)	ADC0 Negative Input (48-pin Package)
00000	P1.0	P2.0
00001	P1.1	P2.1
00010	P1.2	P2.2
00011	P1.3	P2.3
00100	P1.4	P2.5
00101	P1.5	P2.6
00110	P1.6	P3.0
00111	P1.7	P3.1
01000	P2.0	P3.4
01001	P2.1	P3.5
01010	P2.2	P3.7
01011	P2.3	P4.0
01100	P2.4	P4.3
01101	P2.5	P4.4
01110	P2.6	P4.5
01111	P2.7	P4.6
10000	P3.0	RESERVED
10001	P0.0	P0.3
10010	P0.1	P0.4
10011	P0.4	P1.1
10100	P0.5	P1.2
10101 - 11101	RESERVED	RESERVED
11110	VREF	VREF
11111	GND (Single-Ended Mode)	GND (Single-Ended Mode)

Table 5.1. ADC0 Electrical Characteristics

V_{DD} = 3.0 V, VREF = 2.40 V, –40 to +85 °C unless otherwise specified

Parameter	Conditions	Min	Typ	Max	Units
DC Accuracy					
Resolution			10		bits
Integral Nonlinearity			±0.5	±1	LSB
Differential Nonlinearity	Guaranteed Monotonic		±0.5	±1	LSB
Offset Error		–15	0	+15	LSB
Full Scale Error		–15	–1	+15	LSB
Offset Temperature Coefficient			10		ppm/°C
Dynamic Performance (10 kHz sine-wave Single-ended input, 1 dB below Full Scale, 200 ksps)					
Signal-to-Noise Plus Distortion		51	52.5		dB
Total Harmonic Distortion	Up to the 5th harmonic		–67		dB
Spurious-Free Dynamic Range			78		dB
Conversion Rate					
SAR Conversion Clock				3	MHz
Conversion Time in SAR Clocks		10			clocks
Track/Hold Acquisition Time		300			ns
Throughput Rate				200	ksps
Analog Inputs					
ADC Input Voltage Range	Single Ended (AIN+ – GND) Differential (AIN+ – AIN–)	0 –VREF		VREF VREF	V V
Absolute Pin Voltage with respect to GND	Single Ended or Differential	0		V_{DD}	V
Input Capacitance			5		pF
Temperature Sensor					
Linearity[1]			±0.1		°C
Gain			2.86		mV/°C
Gain Error[2]			±33.5		µV/ºC
Offset[1]	(Temp = 0 °C)		776		mV
Offset Error[2]			±8.51		mV
Power Specifications					
Power Supply Current (V_{DD} supplied to ADC0)	Operating Mode, 200 ksps		400	900	µA
Power Supply Rejection			±0.3		mV/V

Notes:

1. Includes ADC offset, gain, and linearity variations.
2. Represents one standard deviation from the mean.

9.4. Power Management Modes

The CIP-51 core has two software programmable power management modes: Idle and Stop. Idle mode halts the CPU while leaving the peripherals and clocks active. In Stop mode, the CPU is halted, all interrupts, are inactive, and the internal oscillator is stopped (analog peripherals remain in their selected states; the external oscillator is not affected). Since clocks are running in Idle mode, power consumption is dependent upon the system clock frequency and the number of peripherals left in active mode before entering Idle. Stop mode consumes the least power. Figure 1.15 describes the Power Control Register (PCON) used to control the CIP-51's power management modes.

Although the CIP-51 has Idle and Stop modes built in (as with any standard 8051 architecture), power management of the entire MCU is better accomplished through system clock and individual peripheral management. Each analog peripheral can be disabled when not in use and placed in low power mode. Digital peripherals, such as timers or serial buses, draw little power when they are not in use. Turning off the oscillators lowers power consumption considerably; however a reset is required to restart the MCU.

The internal oscillator can be placed in Suspend mode (see **Section “14. Oscillators” on page 131**). In Suspend mode, the internal oscillator is stopped until a non-idle USB event is detected, or the VBUS input signal matches the polarity selected by the VBPOL bit in register REG0CN (SFR Definition 8.1).

9.4.1. Idle Mode

Setting the Idle Mode Select bit (PCON.0) causes the CIP-51 to halt the CPU and enter Idle mode as soon as the instruction that sets the bit completes execution. All internal registers and memory maintain their original data. All analog and digital peripherals can remain active during Idle mode.

Idle mode is terminated when an enabled interrupt is asserted or a reset occurs. The assertion of an enabled interrupt will cause the Idle Mode Selection bit (PCON.0) to be cleared and the CPU to resume operation. The pending interrupt will be serviced and the next instruction to be executed after the return from interrupt (RETI) will be the instruction immediately following the one that set the Idle Mode Select bit. If Idle mode is terminated by an internal or external reset, the CIP-51 performs a normal reset sequence and begins program execution at address 0x0000.

If enabled, the Watchdog Timer (WDT) will eventually cause an internal watchdog reset and thereby terminate the Idle mode. This feature protects the system from an unintended permanent shutdown in the event of an inadvertent write to the PCON register. If this behavior is not desired, the WDT may be disabled by software prior to entering the Idle mode if the WDT was initially configured to allow this operation. This provides the opportunity for additional power savings, allowing the system to remain in the Idle mode indefinitely, waiting for an external stimulus to wake up the system. Refer to **Section “11.6. PCA Watchdog Timer Reset” on page 103** for more information on the use and configuration of the WDT.

9.4.2. Stop Mode

Setting the Stop Mode Select bit (PCON.1) causes the CIP-51 to enter Stop mode as soon as the instruction that sets the bit completes execution. In Stop mode the internal oscillator, CPU, and all digital peripherals are stopped; the state of the external oscillator circuit is not affected. Each analog peripheral (including the external oscillator circuit) may be shut down individually prior to entering Stop Mode. Stop mode can only be terminated by an internal or external reset. On reset, the CIP-51 performs the normal reset sequence and begins program execution at address 0x0000.

If enabled, the Missing Clock Detector will cause an internal reset and thereby terminate the Stop mode. The Missing Clock Detector should be disabled if the CPU is to be put to in STOP mode for longer than the MCD timeout of 100 µsec.

11. Reset Sources

Reset circuitry allows the controller to be easily placed in a predefined default condition. On entry to this reset state, the following occur:

- CIP-51 halts program execution
- Special Function Registers (SFRs) are initialized to their defined reset values
- External Port pins are forced to a known state
- Interrupts and timers are disabled.

All SFRs are reset to the predefined values noted in the SFR detailed descriptions. The contents of internal data memory are unaffected during a reset; any previously stored data is preserved. However, since the stack pointer SFR is reset, the stack is effectively lost even though the data on the stack is not altered.

The Port I/O latches are reset to 0xFF (all logic ones) in open-drain mode. Weak pull-ups are enabled during and after the reset. For V_{DD} Monitor and Power-On Resets, the $\overline{RST}$ pin is driven low until the device exits the reset state.

On exit from the reset state, the program counter (PC) is reset, and the system clock defaults to the internal oscillator. Refer to **Section “14. Oscillators” on page 131** for information on selecting and configuring the system clock source. The Watchdog Timer is enabled with the system clock divided by 12 as its clock source (**Section “22.3. Watchdog Timer Mode” on page 264** details the use of the Watchdog Timer). Program execution begins at location 0x0000.

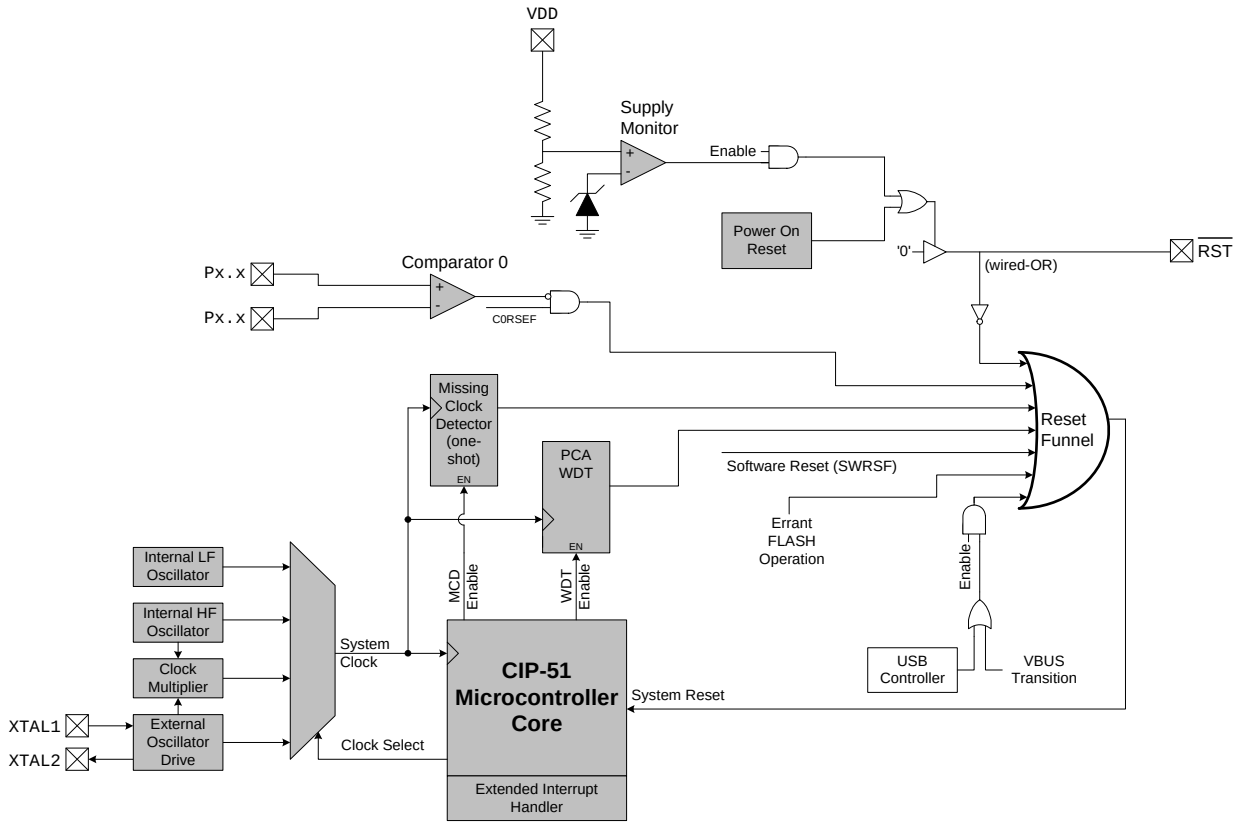

Figure 11.1. Reset Sources

13.3. Configuring the External Memory Interface

Configuring the External Memory Interface consists of five steps:

1. Configure the Output Modes of the associated port pins as either push-pull or open-drain (push-pull is most common), and skip the associated pins in the crossbar.
2. Configure Port latches to “park” the EMIF pins in a dormant state (usually by setting them to logic ‘1’).
3. Select Multiplexed mode or Non-multiplexed mode.
4. Select the memory mode (on-chip only, split mode without bank select, split mode with bank select, or off-chip only).
5. Set up timing to interface with off-chip memory or peripherals.

Each of these five steps is explained in detail in the following sections. The Port selection, Multiplexed mode selection, and Mode bits are located in the EMI0CF register shown in SFR Definition 13.2.

13.4. Port Configuration

The External Memory Interface appears on Ports 4, 3, 2, and 1 when it is used for off-chip memory access. When the EMIF is used, the Crossbar should be configured to skip over the control lines P1.7 ($\overline{WR}$), P1.6 ($\overline{RD}$), and if multiplexed mode is selected P1.3 (ALE) using the P1SKIP register. For more information about configuring the Crossbar, see **Section “Figure 15.1. Port I/O Functional Block Diagram (Port 0 through Port 3)” on page 142**.

The External Memory Interface claims the associated Port pins for memory operations ONLY during the execution of an off-chip MOVX instruction. Once the MOVX instruction has completed, control of the Port pins reverts to the Port latches or to the Crossbar settings for those pins. See **Section “15. Port Input/ Output” on page 142** for more information about the Crossbar and Port operation and configuration. **The Port latches should be explicitly configured to ‘park’ the External Memory Interface pins in a dormant state, most commonly by setting them to a logic 1**.

During the execution of the MOVX instruction, the External Memory Interface will explicitly disable the drivers on all Port pins that are acting as Inputs (Data[7:0] during a READ operation, for example). The Output mode of the Port pins (whether the pin is configured as Open-Drain or Push-Pull) is unaffected by the External Memory Interface operation, and remains controlled by the PnMDOUT registers. In most cases, the output modes of all EMIF pins should be configured for push-pull mode.

SFR Definition 13.1. EMI0CN: External Memory Interface Control

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
PGSEL7	PGSEL6	PGSEL5	PGSEL4	PGSEL3	PGSEL2	PGSEL1	PGSEL0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

SFR Address: 0xAA

Bits7–0: PGSEL[7:0]: XRAM Page Select Bits.
The XRAM Page Select Bits provide the high byte of the 16-bit external data memory address when using an 8-bit MOVX command, effectively selecting a 256-byte page of RAM.
0x00: 0x0000 to 0x00FF
0x01: 0x0100 to 0x01FF
...
0xFE: 0xFE00 to 0xFEFF
0xFF: 0xFF00 to 0xFFFF

13.7.1. Non-multiplexed Mode

13.7.1.1.16-bit MOVX: EMI0CF[4:2] = ‘101’, ‘110’, or ‘111’.

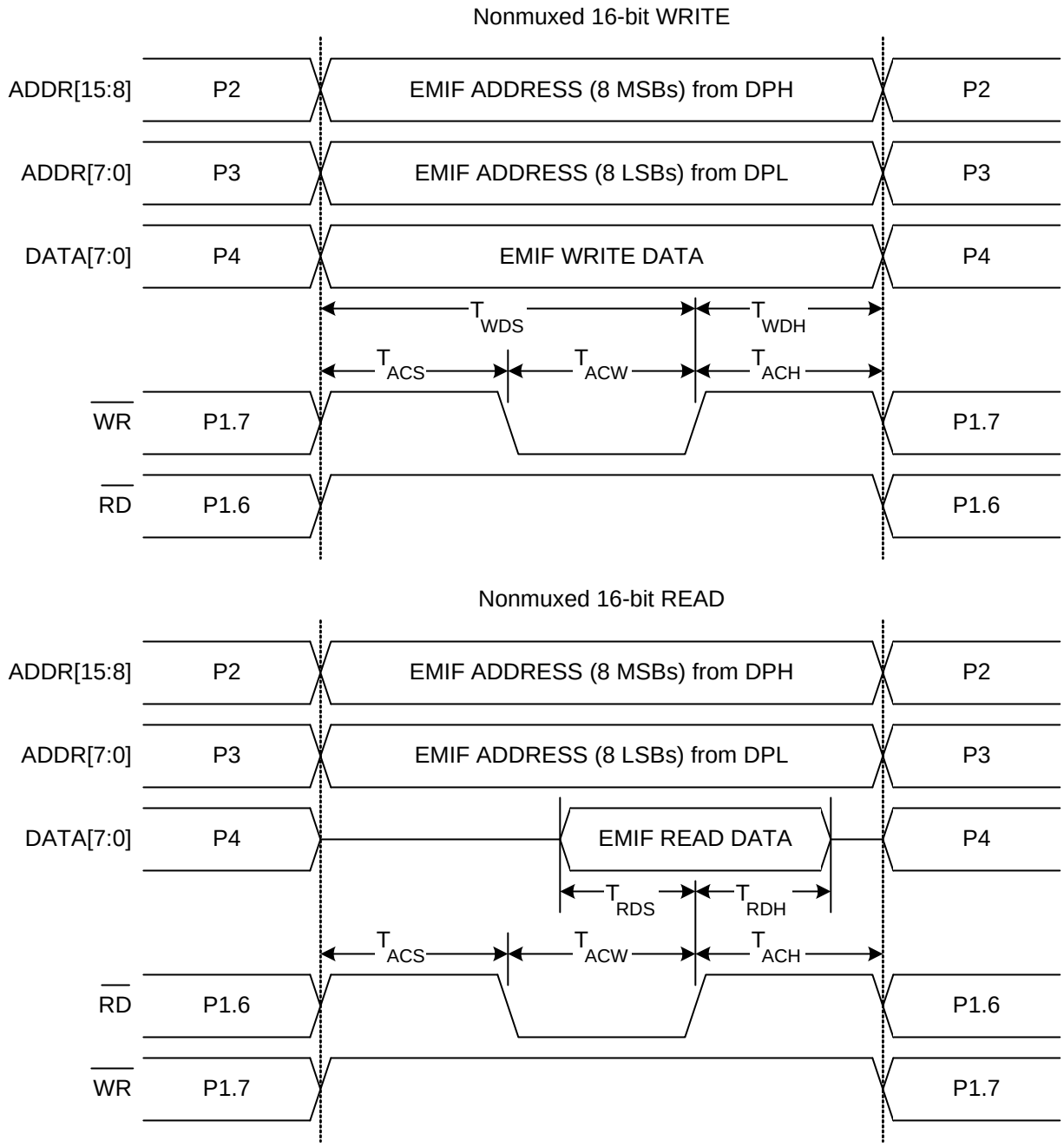

Figure 13.5. Non-multiplexed 16-bit MOVX Timing

14.1. Programmable Internal High-Frequency (H-F) Oscillator

All C8051F34x devices include a programmable internal oscillator that defaults as the system clock after a system reset. The internal oscillator period can be programmed via the OSCICL register shown in SFR Definition 14.2. The OSCICL register is factory calibrated to obtain a 12 MHz internal oscillator frequency. Electrical specifications for the precision internal oscillator are given in Table 14.1 on page 141. Note that the system clock may be derived from the programmed internal oscillator divided by 1, 2, 4, or 8, as defined by the IFCN bits in register OSCICN. The divide value defaults to 8 following a reset.

14.1.1. Internal H-F Oscillator Suspend Mode

The internal high-frequency oscillator may be placed in Suspend mode by writing '1' to the SUSPEND bit in register OSCICN. In Suspend mode, the internal H-F oscillator is stopped until a non-idle USB event is detected (**Section 16**) or VBUS matches the polarity selected by the VBPOL bit in register REG0CN (**Section 8.2**). Note that the USB transceiver can still detect USB events when it is disabled.

SFR Definition 14.1. OSCICN: Internal H-F Oscillator Control

R/W	R	R/W	R	R/W	R/W	R/W	R/W	Reset Value
IOSCEN	IFRDY	SUSPEND	-	-	-	IFCN1	IFCN0	10000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xB2

Bit7: IOSCEN: Internal H-F Oscillator Enable Bit.
0: Internal H-F Oscillator Disabled.
1: Internal H-F Oscillator Enabled.

Bit6: IFRDY: Internal H-F Oscillator Frequency Ready Flag.
0: Internal H-F Oscillator is not running at programmed frequency.
1: Internal H-F Oscillator is running at programmed frequency.

Bit5: SUSPEND: Force Suspend
Writing a '1' to this bit will force the internal H-F oscillator to be stopped. The oscillator will be re-started on the next non-idle USB event (i.e., RESUME signaling) or VBUS interrupt event (see SFR Definition 8.1).

Bits4–2: UNUSED. Read = 000b, Write = don't care.

Bits1–0: IFCN1–0: Internal H-F Oscillator Frequency Control.
00: SYSCLK derived from Internal H-F Oscillator divided by 8.
01: SYSCLK derived from Internal H-F Oscillator divided by 4.
10: SYSCLK derived from Internal H-F Oscillator divided by 2.
11: SYSCLK derived from Internal H-F Oscillator divided by 1.

SFR Definition 14.4. OSCXCN: External Oscillator Control

R	R/W	R/W	R/W	R	R/W	R/W	R/W	Reset Value
XTLVLD	XOSCMD2	XOSCMD1	XOSCMD0	-	XFCN2	XFCN1	XFCN0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xB1

Bit7: XTLVLD: Crystal Oscillator Valid Flag.
(Read only when XOSCMD = 11x.)
0: Crystal Oscillator is unused or not yet stable.
1: Crystal Oscillator is running and stable.

Bits6–4: XOSCMD2–0: External Oscillator Mode Bits.
00x: External Oscillator circuit off.
010: External CMOS Clock Mode.
011: External CMOS Clock Mode with divide by 2 stage.
100: RC Oscillator Mode.
101: Capacitor Oscillator Mode.
110: Crystal Oscillator Mode.
111: Crystal Oscillator Mode with divide by 2 stage.

Bit3: RESERVED. Read = 0, Write = don't care.

Bits2–0: XFCN2–0: External Oscillator Frequency Control Bits.
000-111: See table below:

XFCN	Crystal (XOSCMD = 11x)	RC (XOSCMD = 10x)	C (XOSCMD = 10x)
000	f ≤ 32 kHz	f ≤ 25 kHz	K Factor = 0.87
001	32 kHz < f ≤ 84kHz	25 kHz < f ≤ 50 kHz	K Factor = 2.6
010	84 kHz < f ≤ 225 kHz	50 kHz < f ≤ 100 kHz	K Factor = 7.7
011	225 kHz < f ≤ 590 kHz	100 kHz < f ≤ 200 kHz	K Factor = 22
100	590 kHz < f ≤ 1.5 MHz	200 kHz < f ≤ 400 kHz	K Factor = 65
101	1.5 MHz < f ≤ 4 MHz	400 kHz < f ≤ 800 kHz	K Factor = 180
110	4 MHz < f ≤ 10 MHz	800 kHz < f ≤ 1.6 MHz	K Factor = 664
111	10 MHz < f ≤ 30 MHz	1.6 MHz < f ≤ 3.2 MHz	K Factor = 1590

CRYSTAL MODE (Circuit from Figure 14.1, Option 1; XOSCMD = 11x)
Choose XFCN value to match crystal or resonator frequency.

RC MODE (Circuit from Figure 14.1, Option 2; XOSCMD = 10x)
Choose XFCN value to match frequency range:
$f = 1.23(10^3) / (R \times C)$, where
f = frequency of clock in MHz
C = capacitor value in pF
R = Pull-up resistor value in kΩ

C MODE (Circuit from Figure 14.1, Option 3; XOSCMD = 10x)
Choose K Factor (KF) for the oscillation frequency desired:
$f = KF / (C \times V_{DD})$, where
f = frequency of clock in MHz
C = capacitor value the XTAL2 pin in pF
V_{DD} = Power Supply on MCU in volts

Internal Oscillator		
Clock Signal	**Input Source Selection**	**Register Bit Settings**
USB Clock	External Oscillator / 4	USBCLK = 101b
External Oscillator	Crystal Oscillator Mode 24 MHz Crystal	XOSCMD = 110b XFCN = 111b

SFR Definition 14.6. CLKSEL: Clock Select

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
-	USBCLK			-	CLKSL			00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address
								0xA9

Bit 7: Unused. Read = 0b; Write = don't care.

Bits6–4: USBCLK2–0: USB Clock Select

These bits select the clock supplied to USB0. When operating USB0 in full-speed mode, the selected clock should be 48 MHz. When operating USB0 in low-speed mode, the selected clock should be 6 MHz.

USBCLK	Selected Clock
000	4x Clock Multiplier
001	Internal Oscillator / 2
010	External Oscillator
011	External Oscillator / 2
100	External Oscillator / 3
101	External Oscillator / 4
110	RESERVED
111	RESERVED

Bit3: Unused. Read = 0b; Write = don't care.

Bits2–0: CLKSL2–0: System Clock Select

These bits select the system clock source. When operating from a system clock of 25 MHz or less, the FLRT bit should be set to '0'. When operating with a system clock of greater than 25 MHz (up to 48 MHz), the FLRT bit (FLSCL.4) should be set to '1'. See **Section "10. Prefetch Engine" on page 99** for more details.

CLKSL	Selected Clock
000	Internal Oscillator (as determined by the IFCN bits in register OSCICN)
001	External Oscillator
010	4x Clock Multiplier / 2
011*	4x Clock Multiplier*
100	Low-Frequency Oscillator
101-111	RESERVED
***Note:** This option is only available on 48 MHz devices.	

16.1. Endpoint Addressing

A total of eight endpoint pipes are available. The control endpoint (Endpoint0) always functions as a bi-directional IN/OUT endpoint. The other endpoints are implemented as three pairs of IN/OUT endpoint pipes:

Table 16.1. Endpoint Addressing Scheme

Endpoint	Associated Pipes	USB Protocol Address
Endpoint0	Endpoint0 IN	0x00
	Endpoint0 OUT	0x00
Endpoint1	Endpoint1 IN	0x81
	Endpoint1 OUT	0x01
Endpoint2	Endpoint2 IN	0x82
	Endpoint2 OUT	0x02
Endpoint3	Endpoint3 IN	0x83
	Endpoint3 OUT	0x03

16.2. USB Transceiver

The USB Transceiver is configured via the USB0XCN register shown in SFR Definition 16.1. This configuration includes Transceiver enable/disable, pull-up resistor enable/disable, and device speed selection (Full or Low Speed). When bit SPEED = '1', USB0 operates as a Full Speed USB function, and the on-chip pull-up resistor (if enabled) appears on the D+ pin. When bit SPEED = '0', USB0 operates as a Low Speed USB function, and the on-chip pull-up resistor (if enabled) appears on the D- pin. Bits4-0 of register USB0XCN can be used for Transceiver testing as described in SFR Definition 16.1. The pull-up resistor is enabled only when VBUS is present (see **Section "8.2. VBUS Detection" on page 69** for details on VBUS detection).

Important Note: The USB clock should be active before the Transceiver is enabled.

SFR Definition 16.3. USB0DAT: USB0 Data

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
USB0DAT								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0x97

This SFR is used to indirectly read and write USB0 registers.

Write Procedure:
1. Poll for BUSY (USB 0ADR.7) => ‘0’.
2. Load the target USB0 register address into the USBADDR bits in register USB0ADR.
3. Write data to USB0DAT.
4. Repeat (Step 2 may be skipped when writing to the same USB0 register).

Read Procedure:
1. Poll for BUSY (USB 0ADR.7) => ‘0’.
2. Load the target USB0 register address into the USBADDR bits in register USB0ADR.
3. Write ‘1’ to the BUSY bit in register USB0ADR (steps 2 and 3 can be performed in the same write).
4. Poll for BUSY (USB 0ADR.7) => ‘0’.
5. Read data from USB0DAT.
6. Repeat from Step 2 (Step 2 may be skipped when reading the same USB0 register; Step 3 may be skipped when the AUTORD bit (USB0ADR.6) is logic 1).

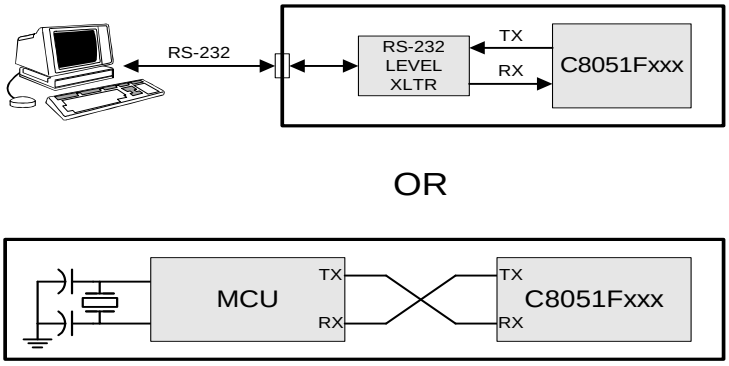

Figure 18.3. UART Interconnect Diagram

18.2.1. 8-Bit UART

8-Bit UART mode uses a total of 10 bits per data byte: one start bit, eight data bits (LSB first), and one stop bit. Data are transmitted LSB first from the TX0 pin and received at the RX0 pin. On receive, the eight data bits are stored in SBUF0 and the stop bit goes into RB80 (SCON0.2).

Data transmission begins when software writes a data byte to the SBUF0 register. The TI0 Transmit Interrupt Flag (SCON0.1) is set at the end of the transmission (the beginning of the stop-bit time). Data reception can begin any time after the REN0 Receive Enable bit (SCON0.4) is set to logic 1. After the stop bit is received, the data byte will be loaded into the SBUF0 receive register if the following conditions are met: RI0 must be logic 0, and if MCE0 is logic 1, the stop bit must be logic 1. In the event of a receive data overrun, the first received 8 bits are latched into the SBUF0 receive register and the following overrun data bits are lost.

If these conditions are met, the eight bits of data is stored in SBUF0, the stop bit is stored in RB80 and the RI0 flag is set. If these conditions are not met, SBUF0 and RB80 will not be loaded and the RI0 flag will not be set. An interrupt will occur if enabled when either TI0 or RI0 is set.

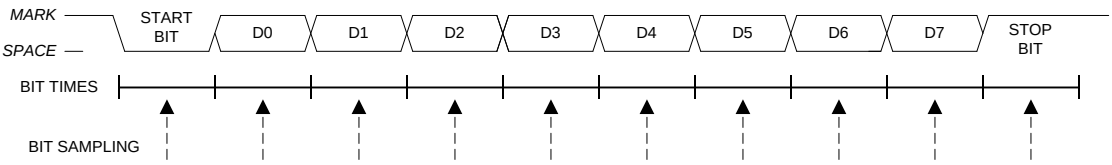

Figure 18.4. 8-Bit UART Timing Diagram

Table 20.1. SPI Slave Timing Parameters

Parameter	Description	Min	Max	Units
Master Mode Timing* (See Figure 20.8 and Figure 20.9)				
T_{MCKH}	SCK High Time	1 x T_{SYSCLK}		ns
T_{MCKL}	SCK Low Time	1 x T_{SYSCLK}		ns
T_{MIS}	MISO Valid to SCK Shift Edge	1 x T_{SYSCLK} + 20		ns
T_{MIH}	SCK Shift Edge to MISO Change	0		ns
Slave Mode Timing* (See Figure 20.10 and Figure 20.11)				
T_{SE}	NSS Falling to First SCK Edge	2 x T_{SYSCLK}		ns
T_{SD}	Last SCK Edge to NSS Rising	2 x T_{SYSCLK}		ns
T_{SEZ}	NSS Falling to MISO Valid		4 x T_{SYSCLK}	ns
T_{SDZ}	NSS Rising to MISO High-Z		4 x T_{SYSCLK}	ns
T_{CKH}	SCK High Time	5 x T_{SYSCLK}		ns
T_{CKL}	SCK Low Time	5 x T_{SYSCLK}		ns
T_{SIS}	MOSI Valid to SCK Sample Edge	2 x T_{SYSCLK}		ns
T_{SIH}	SCK Sample Edge to MOSI Change	2 x T_{SYSCLK}		ns
T_{SOH}	SCK Shift Edge to MISO Change		4 x T_{SYSCLK}	ns
T_{SLH}	Last SCK Edge to MISO Change (CKPHA = 1 ONLY)	6 x T_{SYSCLK}	8 x T_{SYSCLK}	ns

***Note:** T_{SYSCLK} is equal to one period of the device system clock (SYSCLK).

SFR Definition 21.4. TL0: Timer 0 Low Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0x8A

Bits 7–0: TL0: Timer 0 Low Byte.
The TL0 register is the low byte of the 16-bit Timer 0.

SFR Definition 21.5. TL1: Timer 1 Low Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0x8B

Bits 7–0: TL1: Timer 1 Low Byte.
The TL1 register is the low byte of the 16-bit Timer 1.

SFR Definition 21.6. TH0: Timer 0 High Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0x8C

Bits 7–0: TH0: Timer 0 High Byte.
The TH0 register is the high byte of the 16-bit Timer 0.

SFR Definition 21.7. TH1: Timer 1 High Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0x8D

Bits 7–0: TH1: Timer 1 High Byte.
The TH1 register is the high byte of the 16-bit Timer 1.

SFR Definition 22.4. PCA0L: PCA Counter/Timer Low Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0xF9

Bits 7–0: PCA0L: PCA Counter/Timer Low Byte.
The PCA0L register holds the low byte (LSB) of the 16-bit PCA Counter/Timer.

SFR Definition 22.5. PCA0H: PCA Counter/Timer High Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0xFA

Bits 7–0: PCA0H: PCA Counter/Timer High Byte.
The PCA0H register holds the high byte (MSB) of the 16-bit PCA Counter/Timer.

SFR Definition 22.6. PCA0CPLn: PCA Capture Module Low Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0xFB, 0xE9, 0xEB, 0xED, 0xFD

PCA0CPLn Address: PCA0CPL0 = 0xFB (n = 0), PCA0CPL1 = 0xE9 (n = 1),
PCA0CPL2 = 0xEB (n = 2), PCA0CPL3 = 0xED (n = 3),
PCA0CPL4 = 0xFD (n = 4)

Bits7–0: PCA0CPLn: PCA Capture Module Low Byte.
The PCA0CPLn register holds the low byte (LSB) of the 16-bit capture module n.

SFR Definition 22.7. PCA0CPHn: PCA Capture Module High Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xFC, 0xEA, 0xEC,0xEE, 0xFE

PCA0CPHn Address: PCA0CPH0 = 0xFC (n = 0), PCA0CPH1 = 0xEA (n = 1),
PCA0CPH2 = 0xEC (n = 2), PCA0CPH3 = 0xEE (n = 3),
PCA0CPH4 = 0xFE (n = 4)

Bits7–0: PCA0CPHn: PCA Capture Module High Byte.
The PCA0CPHn register holds the high byte (MSB) of the 16-bit capture module n.

C2 Register Definition 23.3. REVID: C2 Revision ID

Reset Value: Variable

Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0

This read-only register returns the 8-bit revision ID.

C2 Register Definition 23.4. FPCTL: C2 Flash Programming Control

Reset Value: 00000000

Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0

Bits7–0 FPCTL: Flash Programming Control Register.
This register is used to enable Flash programming via the C2 interface. To enable C2 Flash programming, the following codes must be written in order: 0x02, 0x01. Note that once C2 Flash programming is enabled, a system reset must be issued to resume normal operation.

C2 Register Definition 23.5. FPDAT: C2 Flash Programming Data

Reset Value: 00000000

Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0

Bits7–0: FPDAT: C2 Flash Programming Data Register.
This register is used to pass Flash commands, addresses, and data during C2 Flash accesses. Valid commands are listed below.

Code	Command
0x06	Flash Block Read
0x07	Flash Block Write
0x08	Flash Page Erase
0x03	Device Erase